

#### SMARTSTACK<sup>™</sup> SHIPPING KIT FOR 200 MM AND 150 MM WAFERS

Safely protect and transport finished wafers in full, thin or ultra-thin thicknesses

### **Overview**

Whether you ship small lots of wafers or are just demonstrating your latest process technology to your customer, having your product reach the customer in pristine condition maximizes customer satisfaction.

The SmartStack<sup>™</sup> wafer shipping system is designed to reduce wafer breakage, die bond corrosion, and particle contamination to increase IC fab yield and profit.

Entegris' SmartStack<sup>™</sup> Shipping Kit is convenient to use and contains all packing materials required to maintain wafer integrity during transport, storage or shipping of 200 mm or 150 mm wafers.

The SmartStack<sup>™</sup> K200 and K150 are complete shipping kits for 200 mm and 150 mm diameter wafers, respectively. Utilizing the latest in materials and manufacturing technologies, kits are supplied with cleanroom level 100 Tyvek<sup>®</sup> wafer inserts and highdensity, conductive, cross-linked polyethylene cushions to ensure wafer integrity during transport, storage or shipping.

#### Features

- All of the parts required to ship 1 to 25 wafers are provided in one convenient box
- High-density, low-ionic cushions for safe transport of thick, thin, or ultra-thin wafers
- Level 100 packed, low-particle, low-ionic wafer inserts for increased protection against die bond corrosion and particle contamination
- Canister, cushions, wafer inserts and ESD bag packaged in cleanroom media and ready for use
- Cushions and wafer inserts can be used in manual or automated wafer packing processes
- Accommodates 200 mm and 150 mm wafers
- Order on line at *www.devicecare.com*, with tools to help optimize your SmartStack<sup>™</sup> system



Kit contents

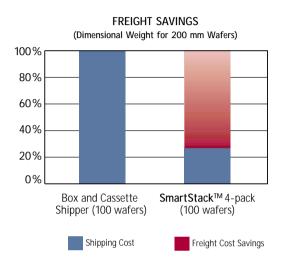
## **Kit Contents**

Shipped in full case quantities, 1 kit per case.

- Canister (1)
- Black, carbon-filled polyethylene inner cushions (13)
- Tyvek<sup>®</sup> level 100 wafer inserts (26)
- ESD bag (1)
- Outer packing cushions (2)
- Corrugated shipping box (1)
- Wafer packing instruction sheet

# **Ordering Information**

Kit	Wafer Size	Part Number
K150	150 mm	HWS150-1PACK-KIT
K200	200 mm	HWS200-1PACK-KIT



# Terms and Conditions of Sale

All purchases are subject to Entegris' "Terms and Conditions of Sale."

## For More Information

To find out more about what Entegris can do for you, please call one of our Regional Customer Service Centers today.

#### **Entegris Regional Customer Service Centers**

	Telephone	Fax	
North America	952-556-4181	952-556-8022	
North America Toll Free	800-394-4083	800-763-5820	
Europe	49-7264-9158-0	49-7264-9158-927	
Japan	81-3-5769-7800	81-3-5769-7845	
Malaysia	604-403-1266	604-403-1262	
Korea	82-31-738-1181	82-31-738-1191	
Taiwan	886-3-5633598 886-3-5633552	886-3-5633521	
Visit Entegris' Web site at www.devicecare.com			

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